

IN THE SPECIFICATION

Page 1, line 1, please change the title from [STACKING STRUCTURE OF SEMICONDUCTOR CHIPS AND SEMICONDUCTOR PACKAGE USING IT], to A STACKED SEMICONDUCTOR PACKAGE HAVING AN INSULATOR TO PREVENT SHORTING OF WIREBONDS.

CLEAN VERSION OF THE SPECIFICATION

Page 1, line 1 should now read "A STACKED SEMICONDUCTOR PACKAGE HAVING AN INSULATOR TO PREVENT SHORTING OF WIREBONDS"